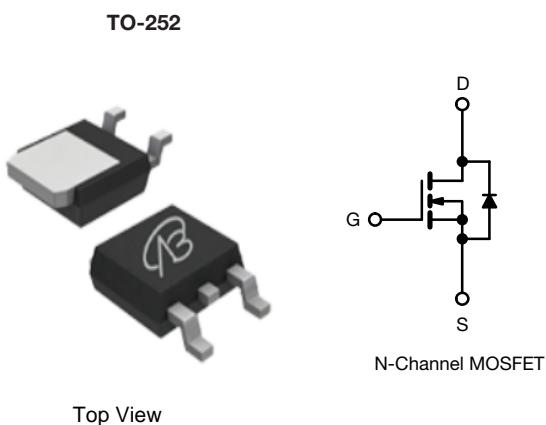


## N-Channel 700V (D-S) Super Junction Power MOSFET

PRODUCT SUMMARY		
$V_{DS}$ (V) at $T_J$ max.	700	
$R_{DS(on)}$ typ. ( $\Omega$ ) at 25 °C	$V_{GS} = 10$ V	0.390

### FEATURES

- Low figure-of-merit (FOM)  $R_{on} \times Q_g$
- Low input capacitance ( $C_{iss}$ )
- Reduced switching and conduction losses
- Ultra low gate charge ( $Q_g$ )
- Avalanche energy rated (UIS)



### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		$V_{DS}$	700	V
Gate-source voltage		$V_{GS}$	$\pm 30$	
Continuous drain current ( $T_J = 150$ °C)	$V_{GS}$ at 10 V	$T_C = 25$ °C	11	A
			6	
Pulsed drain current <sup>a</sup>		$I_{DM}$	33	
Linear derating factor			1.7	W/°C
Single pulse avalanche energy <sup>b</sup>		$E_{AS}$	330	mJ
Maximum power dissipation		$P_D$	180	W
Operating junction and storage temperature range		$T_J, T_{stg}$	-55 to +150	°C
Drain-source voltage slope	$T_J = 125$ °C	dV/dt	50	V/ns
Reverse diode dV/dt <sup>d</sup>			5.1	
Soldering recommendations (peak temperature) <sup>c</sup>	For 10 s		260	°C

#### Notes

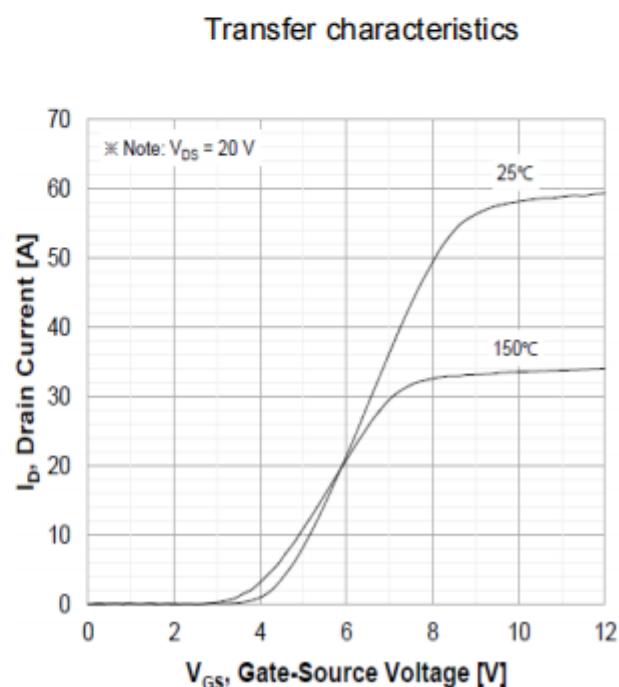
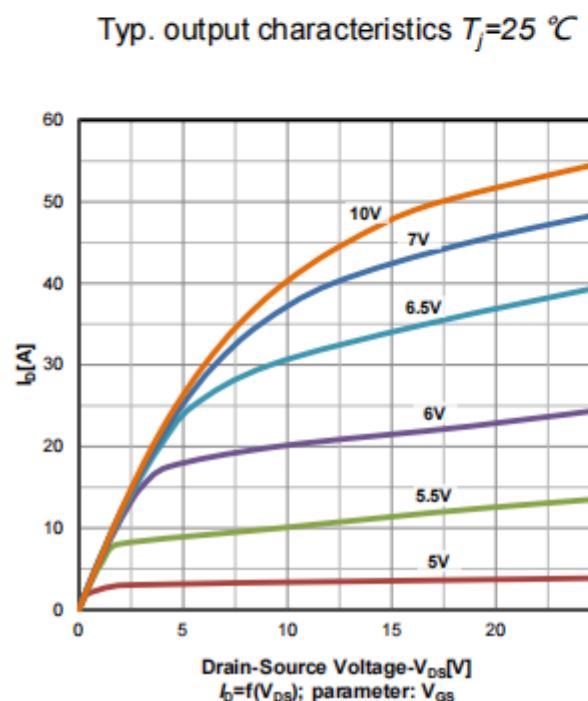
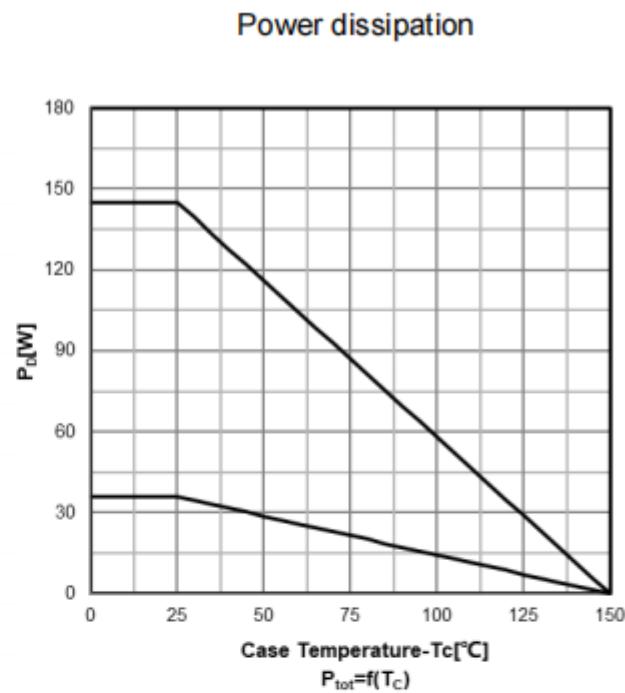
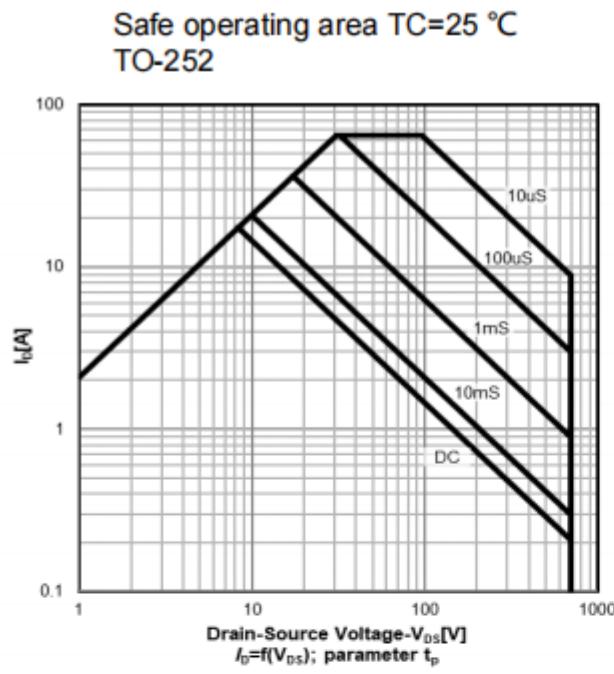
- Repetitive rating; pulse width limited by maximum junction temperature
- $V_{DD} = 100$  V, starting  $T_J = 25$  °C,  $L = 30$  mH,  $R_g = 25$  Ω,  $I_{AS} = 5$  A
- 1.6 mm from case
- $I_{SD} \leq I_D$ ,  $dI/dt = 100$  A/μs, starting  $T_J = 25$  °C

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	$R_{thJA}$	-	62	
Maximum junction-to-case (drain)	$R_{thJC}$	-	0.85	°C/W

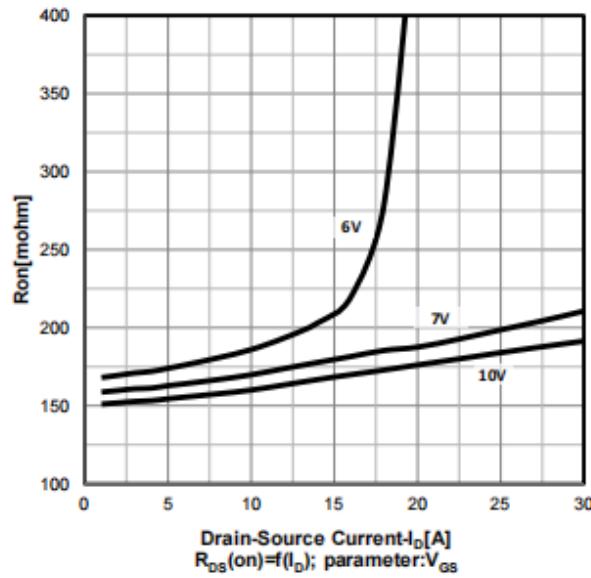
SPECIFICATIONS ( $T_J = 25$ °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
<b>Static</b>							
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0$ V, $I_D = 250$ μA		700	-	-	V
$V_{DS}$ temperature coefficient	$\Delta V_{DS}/T_J$	Reference to 25 °C, $I_D = 1$ mA		-	1.08	-	V/°C
Gate-source threshold Voltage (N)	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 250$ μA		2.0	-	4.0	V
Gate-source leakage	$I_{GSS}$	$V_{GS} = \pm 20$ V		-	-	± 100	nA
		$V_{GS} = \pm 30$ V		-	-	± 1	μA
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 700$ V, $V_{GS} = 0$ V		-	-	1	
		$V_{DS} = 560$ V, $V_{GS} = 0$ V, $T_J = 125$ °C		-	-	10	μA
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS} = 10$ V	$I_D = 3.5$ A	-	0.390	-	Ω
Forward transconductance	$g_{fs}$	$V_{DS} = 30$ V, $I_D = 5$ A		-	8.7	-	S
<b>Dynamic</b>							
Input capacitance	$C_{iss}$	$V_{GS} = 0$ V, $V_{DS} = 100$ V, $f = 1$ MHz		-	2500	-	pF
Output capacitance	$C_{oss}$			-	51	-	
Reverse transfer capacitance	$C_{rss}$			-	12	-	
Effective output capacitance, energy related <sup>a</sup>	$C_{o(er)}$	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	48	-	
Effective output capacitance, time related <sup>b</sup>	$C_{o(tr)}$			-	205	-	
Total gate charge	$Q_g$		$V_{GS} = 10$ V, $I_D = 5$ A, $V_{DS} = 480$ V	-	26	-	nC
Gate-source charge	$Q_{gs}$			-	8	-	
Gate-drain charge	$Q_{gd}$			-	10	-	
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 480$ V, $I_D = 5$ A, $V_{GS} = 10$ V, $R_g = 9.1$ Ω		-	12	24	ns
Rise time	$t_r$			-	14	23	
Turn-off delay time	$t_{d(off)}$			-	61	110	
Fall time	$t_f$			-	16	-	
Gate input resistance	$R_g$	$f = 1$ MHz, open drain		0.3	0.7	1.4	Ω
<b>Drain-Source Body Diode Characteristics</b>							
Continuous source-drain diode current	$I_S$	MOSFET symbol showing the integral reverse p - n junction diode		-	-	11	A
Pulsed diode forward current	$I_{SM}$			-	-	33	
Diode forward voltage	$V_{SD}$	$T_J = 25$ °C, $I_S = 5$ A, $V_{GS} = 0$ V		-	-	1.2	V
Reverse recovery time	$t_{rr}$	$T_J = 25$ °C, $I_F = I_S = 5$ A, $dI/dt = 100$ A/μs, $V_R = 25$ V		-	416	832	ns
Reverse recovery charge	$Q_{rr}$			-	6.4	12.8	
Reverse recovery current	$I_{RRM}$			-	27	-	

**Notes**

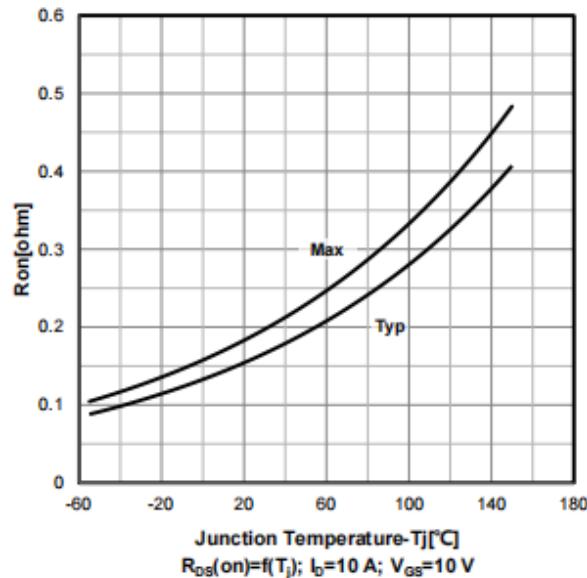
a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$   
 b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)


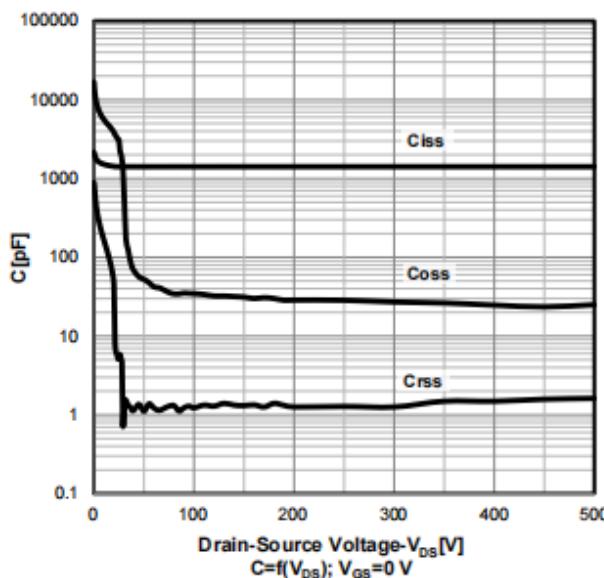
Typ. drain-source on-state resistance



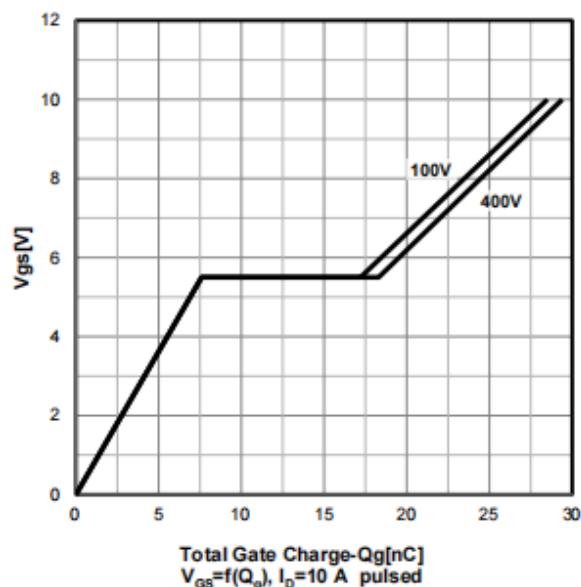
On-resistance vs temperature



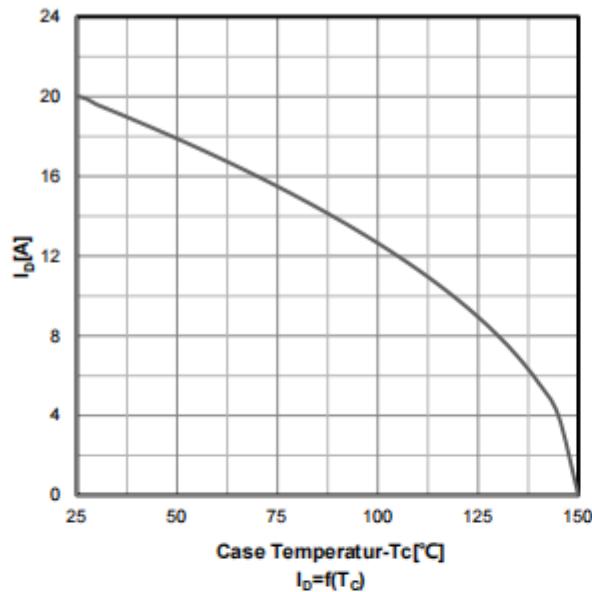
Typ. capacitances



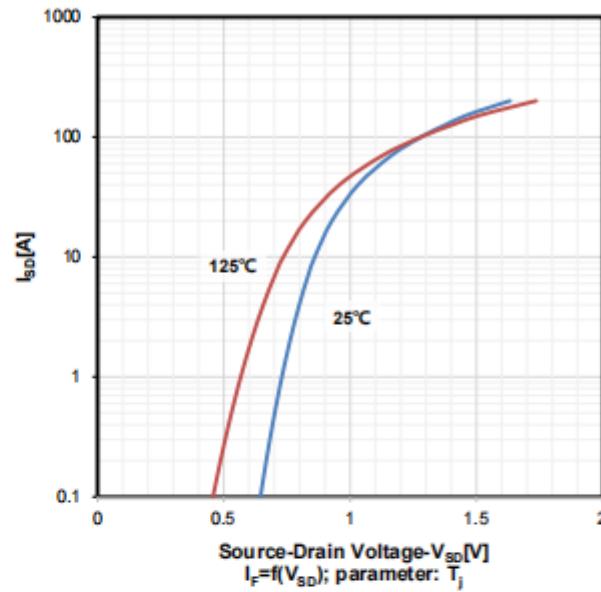
Typ. gate charge characteristics



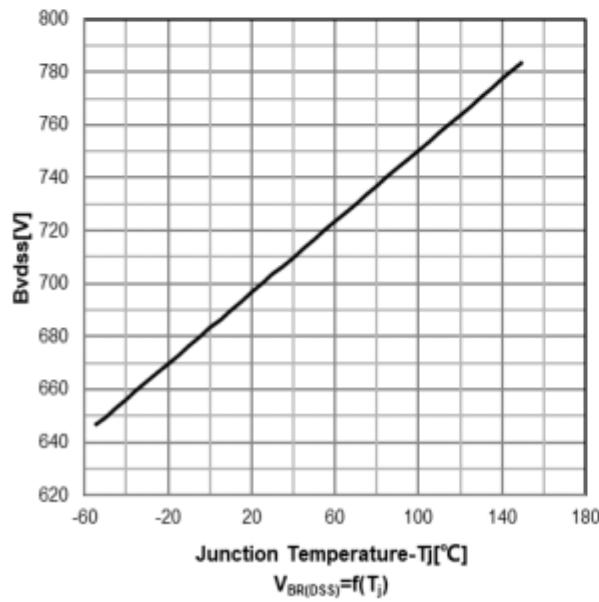
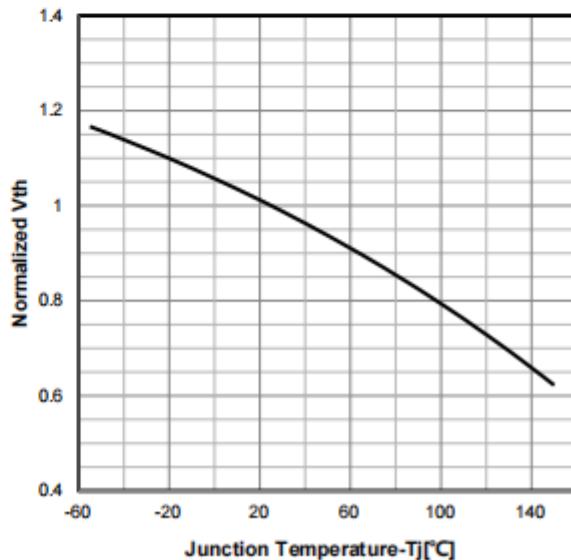
Drain current vs temperature



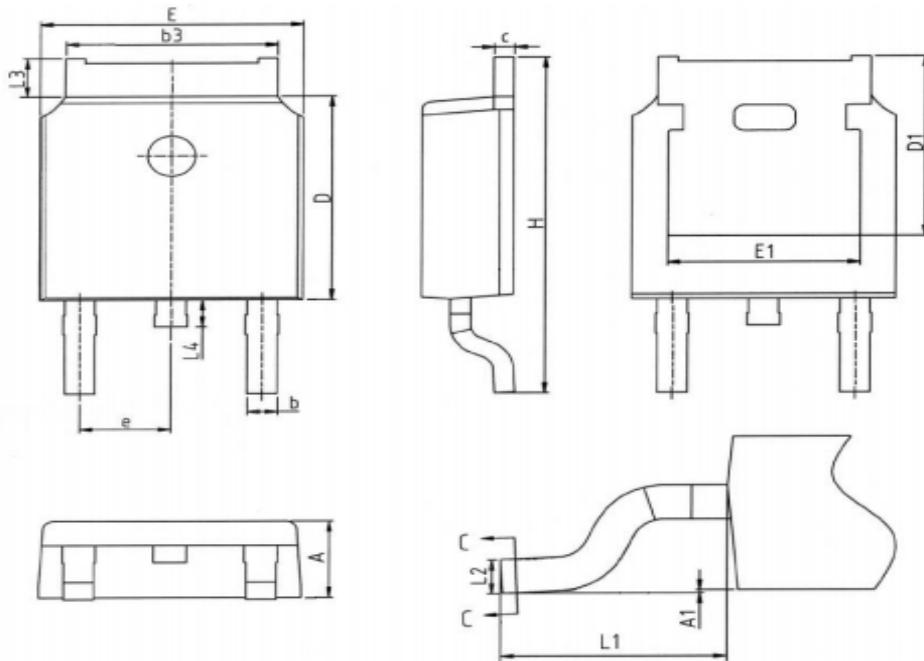
Forward characteristics of reverse diode



Drain-source breakdown voltage

Normalized  $V_{GS(\text{th})}$  characteristics

## Package Outline : TO 252



## COMMON DIMENSIONS

SYMBOL	UNIT(mm)		
	MIN	NOM	MAX
A	2.20	2.30	2.40
A1	0.00	-	0.127
b	0.66	0.78	0.90
b3	5.16	5.31	5.46
c	0.43	0.53	0.63
D	5.98	6.10	6.22
D1	5.30REF		
E	6.40	6.60	6.75
E1	4.63	-	-
e	2.286BSC		
H	9.40	10.10	10.50
L1	2.90REF		
L2	0.51BSC		
L3	0.88	1.08	1.28
L4	0.50	0.80	1.00

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